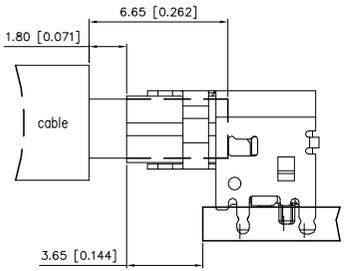
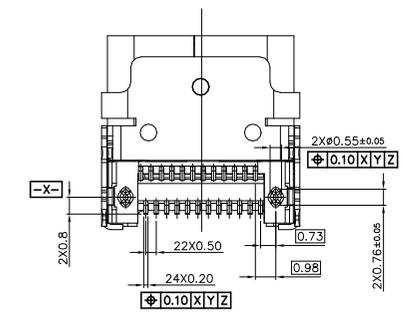
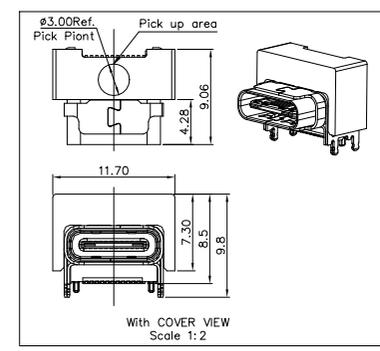
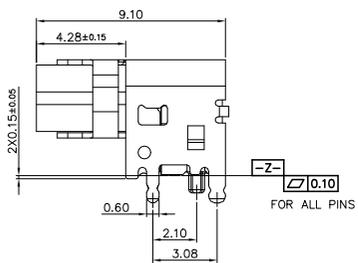
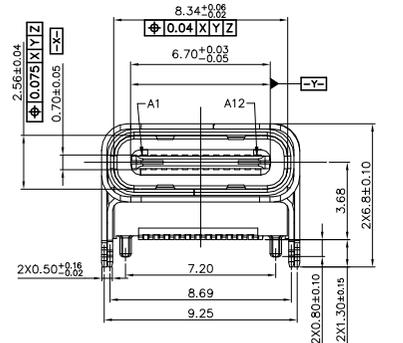
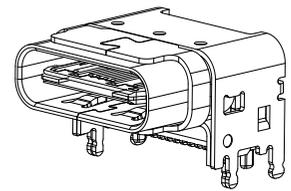
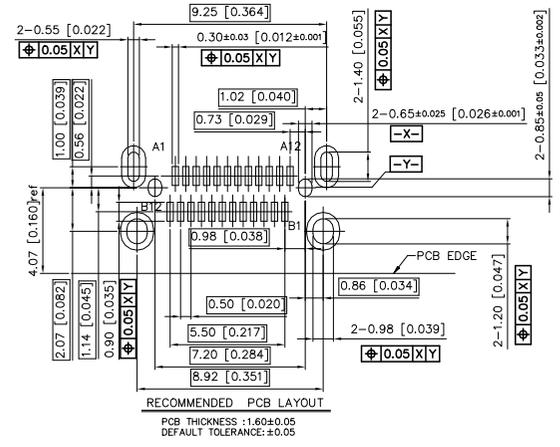
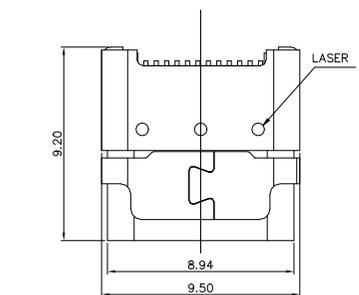


RoHS 2.0+HF

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10	COVER	LCP	1	Black, UL94 V-0
09	UNDER SHELL	SUS304	1	T=0.25 „Solder area Plating Au 1U”
08	OUTER SHELL	SUS304	1	T=0.25,Solder area Plating Au 1U”
07	INNER SHELL	SUS304	1	T=0.30
06	OVER MOULDING		1	Black, UL94 V-0
05	BOTTOM CONTACT I/M	LCP	1	Black, UL94 V-0
04	TOP CONTACT I/M		1	Black, UL94 V-0
03	SHIELDING PLATE	SUS301	1	T=0.15 „Plating nickel
02	BOTTOM CONTACT	Copper alloy	1	T=0.12 Au 30u” Plated at contact area,1U” MIN plated at solder area.
01	TOP CONTACT	Copper alloy	1	T=0.12 Au 30u” Plated at contact area,1U” MIN plated at solder area.
NQ.	VARIETY	MATERIAL	QT,Y	REMARK

一般公差 GENERAL TOLERANCE					绘图 DR.	料号 PART NO. W-UTP-CH368-H01	文件编号 NUMBER ENDPW03	
X.X	±0.35	X°	±6°	审核 CHK.	品名 TITLE USB TYPE C 24PIN CH=3.68			
X.XX	±0.25	X.X°	±3°	核准 APPD.				
X.XXX	±0.15	▲	MAJOR DIM.	单位 UNIT mm				

A0	19.3.12	新版发行	李兴涛	杨章雄
版次 REV.	日期 DATE	变更内容 DESCRIPTION	审核 CHK.	核准 APPD.

A B C D E F